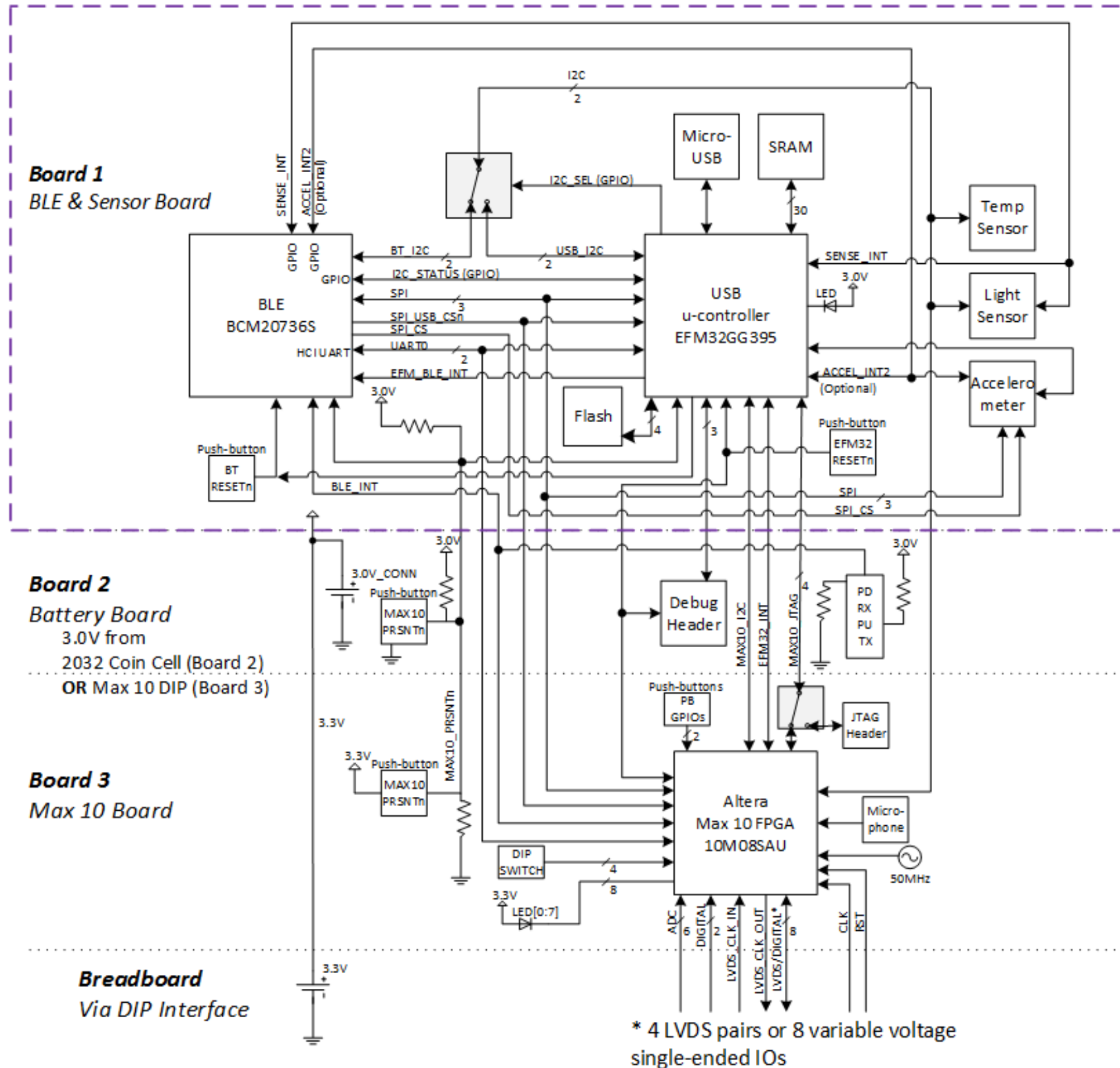


IoT Development Kit

BLE and Sensor board

This schematic is "Board 1" of the complete demonstration board, shown in the block diagram below.



REV	DATE	PAGES	DESCRIPTION
C1	09/18/2014	1	Change J2 pinout so that the mating connector on the Battery or Max 10 board will have pin 1 at the notch, instead of pin 2.
C2	10/24/2014	4-5	BOM update to change R5, R7, R13, and R15 to 4.7K-ohm resistors.
C3	06/18/2015	5	Update LED reference designator numbers in the notes describing the use cases with the Si1147.

PAGE	DESCRIPTION
1	Title, Notes, Block Diagram, Rev. History
2	Power & Connector
3	USB
4	Bluetooth
5	Sensors



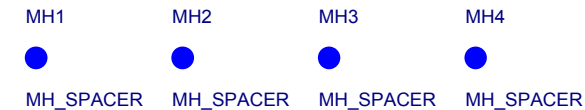
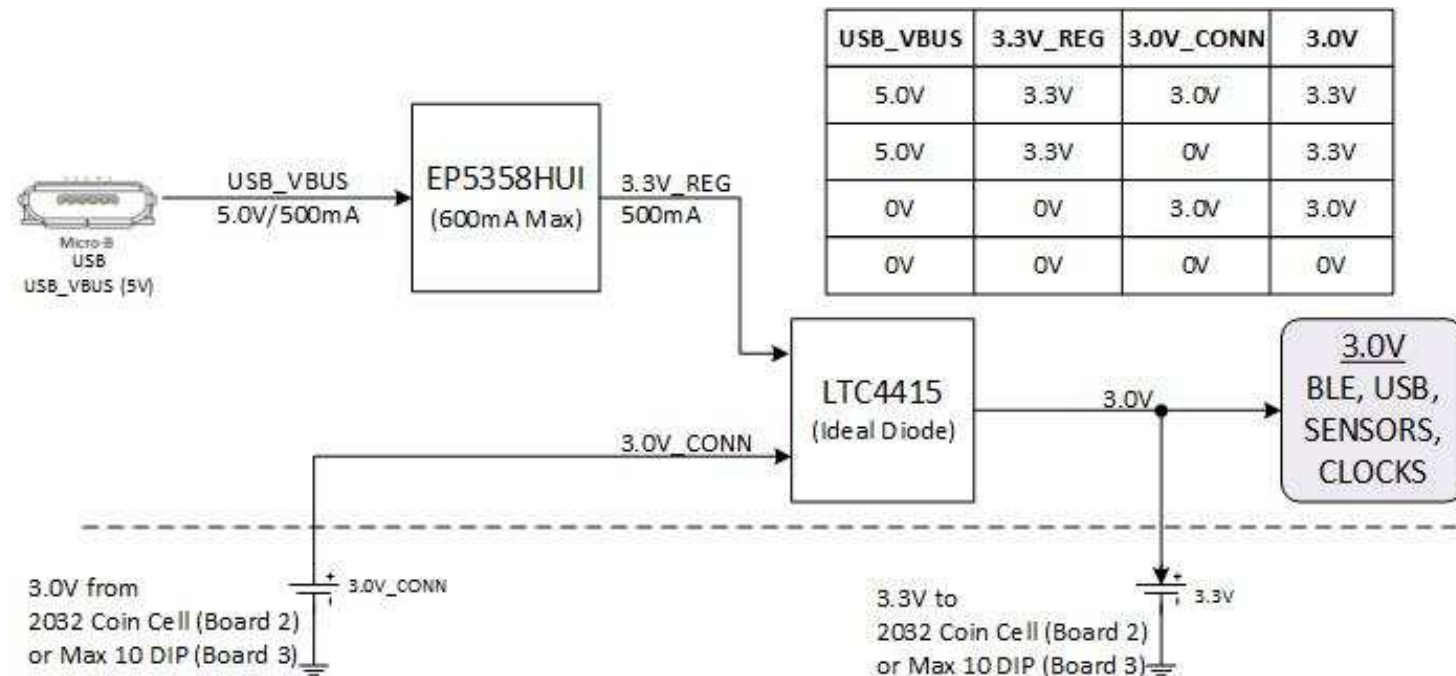
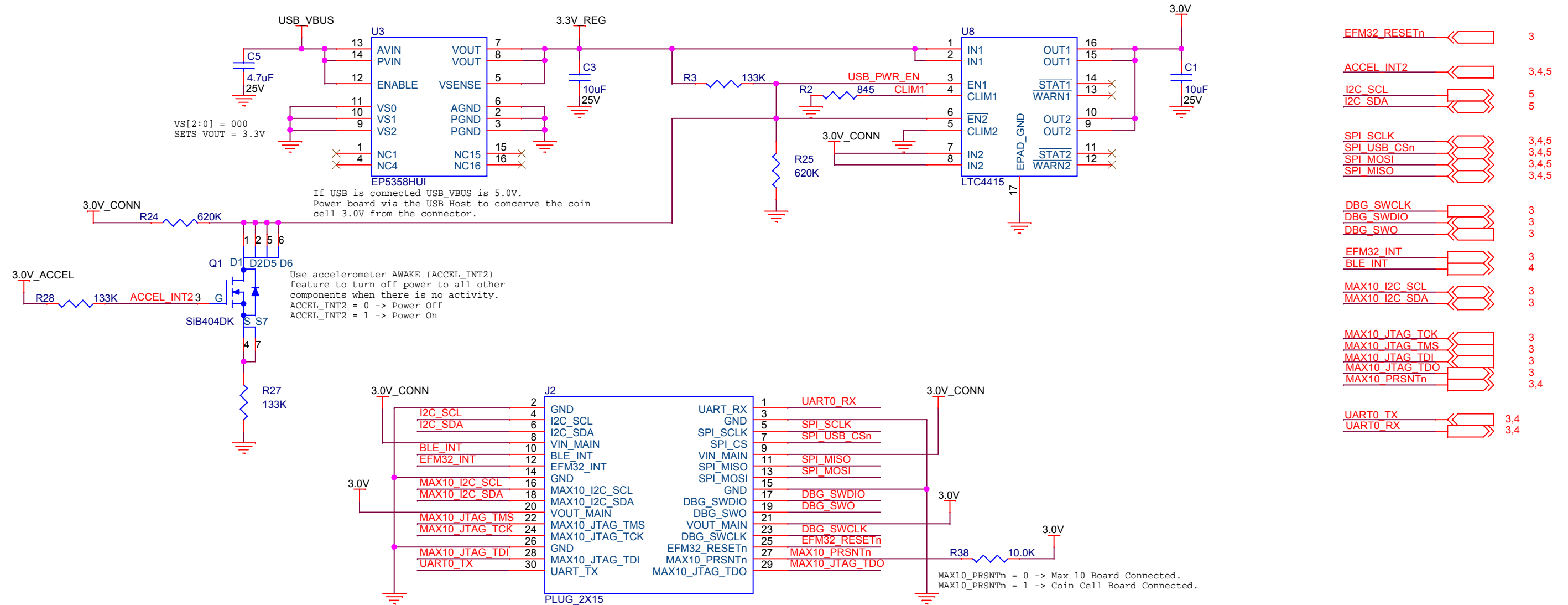
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Title: IoT Development Kit - BLE and Sensor Board

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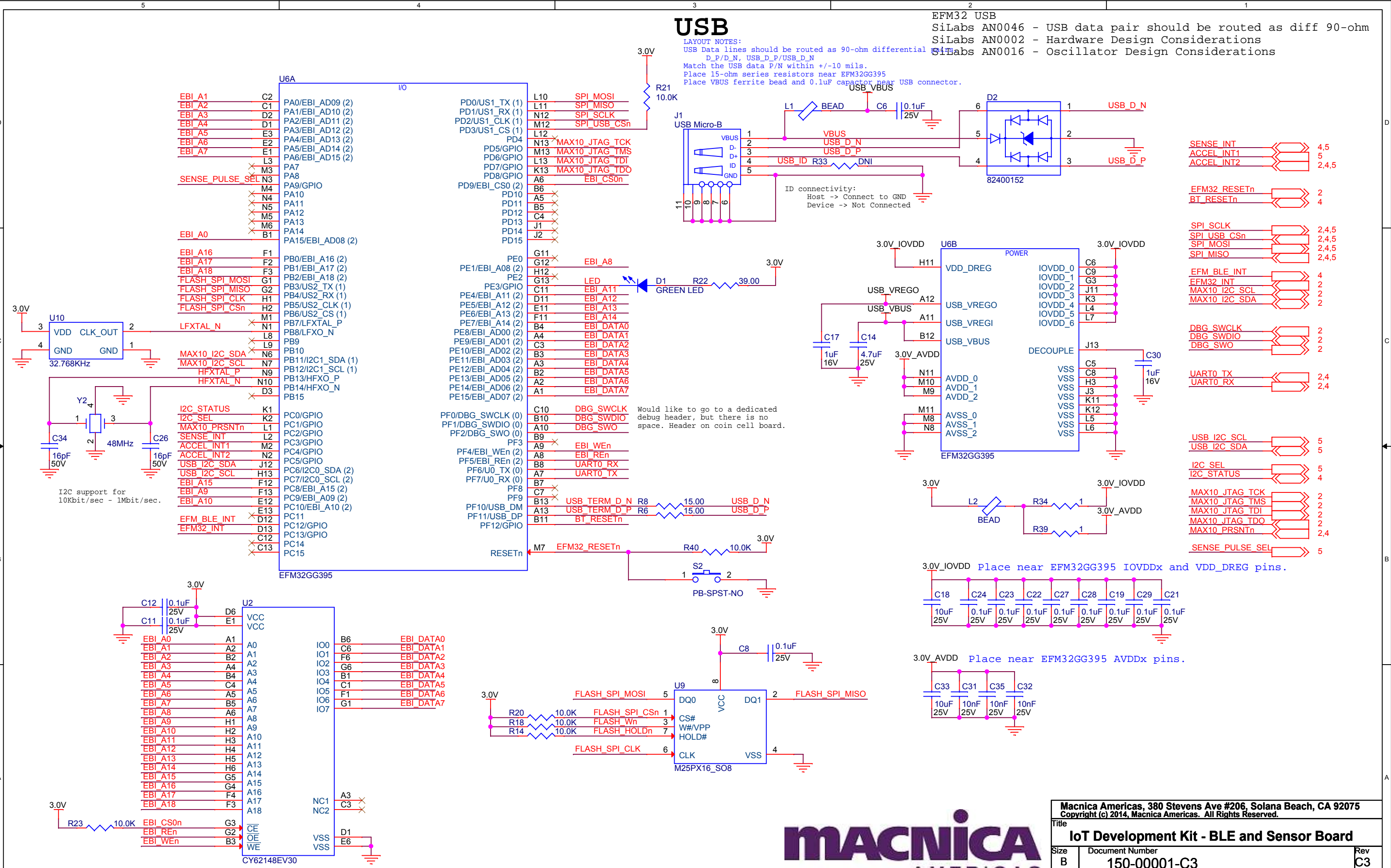
Power & Connector



USB

LAYOUT NOTES:
 USB Data lines should be routed as 90-ohm differential D_P/D_N, USB_D_P/USB_D_N
 Match the USB data P/N within +/-10 mils.
 Place 15-ohm series resistors near EFM32GG395
 Place VBUS ferrite bead and 0.1uF capacitor near USB connector.

EFM32 USB
 SiLabs AN0046 - USB data pair should be routed as diff 90-ohm
 SiLabs AN0002 - Hardware Design Considerations
 SiLabs AN0016 - Oscillator Design Considerations



SENSE_INT 4,5
 ACCEL_INT1 5
 ACCEL_INT2 2,4,5

EFM32_RESETn 2
 BT_RESETn 4

SPI_SCLK 2,4,5
 SPI_USB_CSn 2,4,5
 SPI_MOSI 2,4,5
 SPI_MISO 2,4,5

EFM_BLE_INT 4
 EFM32_INT 2
 MAX10_I2C_SCL 2
 MAX10_I2C_SDA 2

DBG_SWCLK 2
 DBG_SWDIO 2
 DBG_SWO 2

UART0_TX 2,4
 UART0_RX 2,4

USB_I2C_SCL 5
 USB_I2C_SDA 5

I2C_SEL 5
 I2C_STATUS 4

MAX10_JTAG_TCK 2
 MAX10_JTAG_TMS 2
 MAX10_JTAG_TDI 2
 MAX10_JTAG_TDO 2
 MAX10_PRSNtn 2,4

SENSE_PULSE_SEL 5

Place near EFM32GG395 IOVDDx and VDD_DREG pins.

Place near EFM32GG395 AVDDx pins.

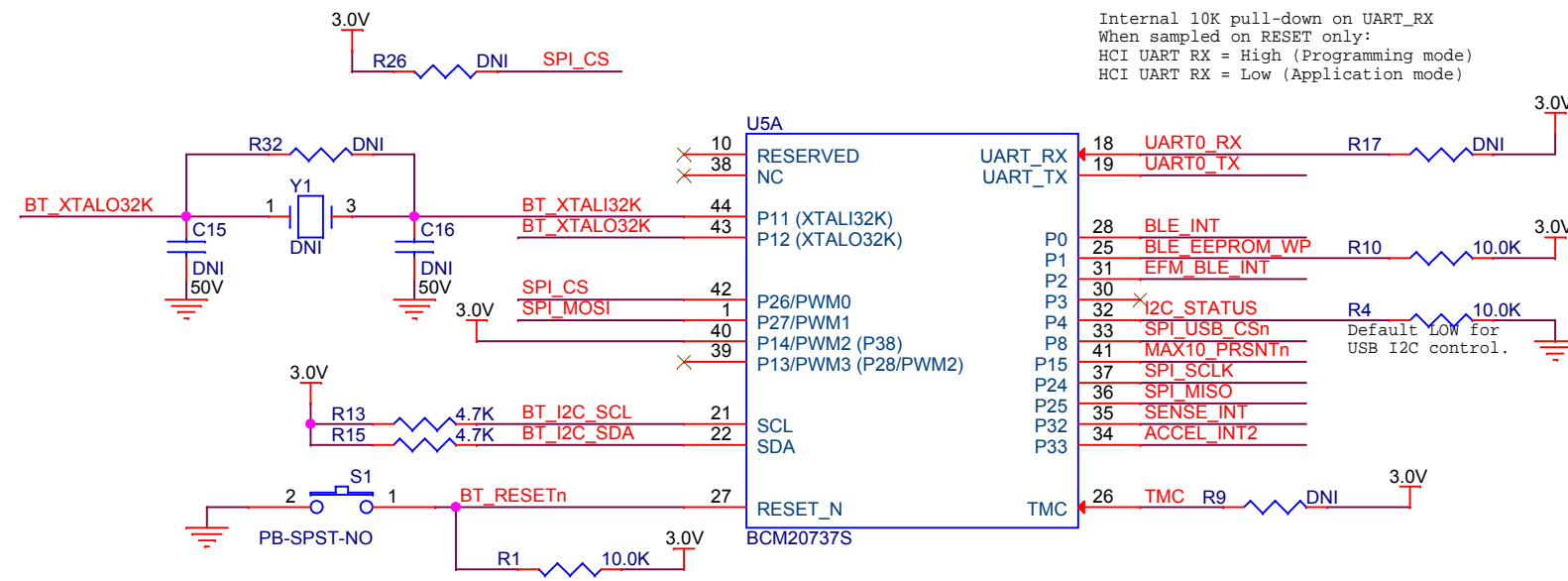
Would like to go to a dedicated debug header, but there is no space. Header on coin cell board.

I2C support for 10Kbit/sec - 1Mbit/sec.



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Bluetooth

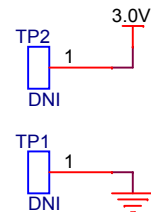
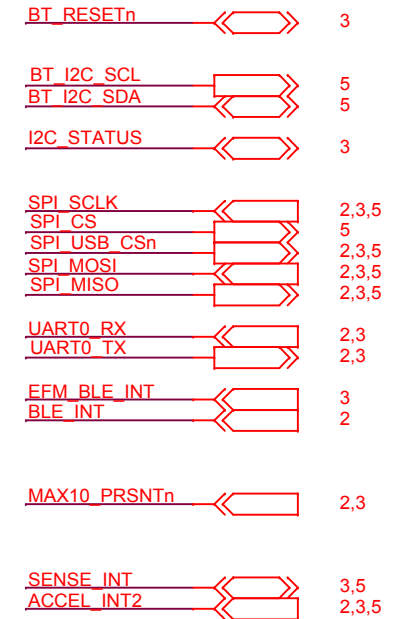
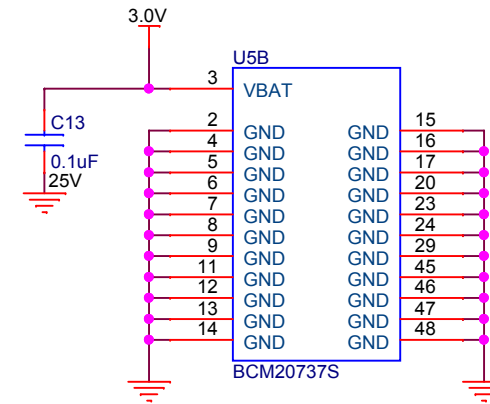


Internal 10K pull-down on UART_RX
 When sampled on RESET only:
 HCI UART RX = High (Programming mode)
 HCI UART RX = Low (Application mode)

SPIFFY1 MASTER (ONLY)
 CS = P33
 SCLK = SCL
 MOSI = SDA
 MISO = P32

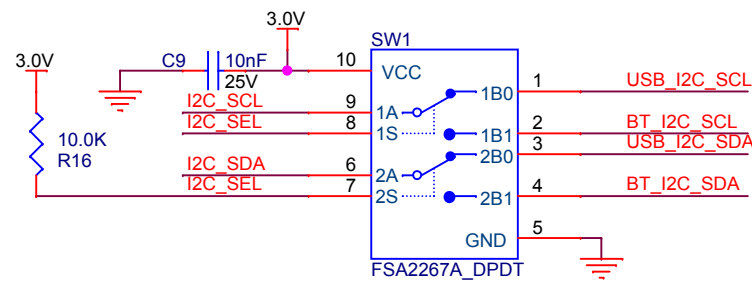
SPIFFY2 MASTER
 CS0 = P26 (SPI_CS to accelerometer)
 CS1 = P8 (SPI_USB_CSn to USB/uController)
 SCLK = P24
 MOSI = P27
 MISO = P25

SPIFFY2 SLAVE
 SCLK = P24
 MOSI = P27
 MISO = P25



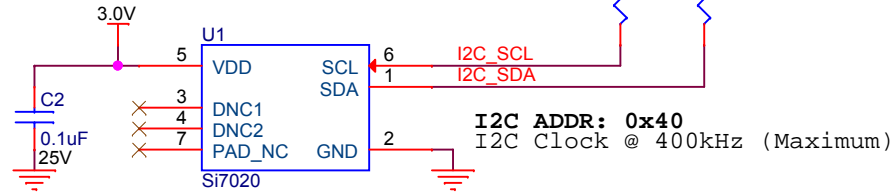
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Sensors



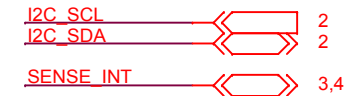
ISC_SEL = 0 -> Connect A to B0 (USB I2C)
ISC_SEL = 1 -> Connect A to B1 (BT I2C)

Humidity/Temp Sensor

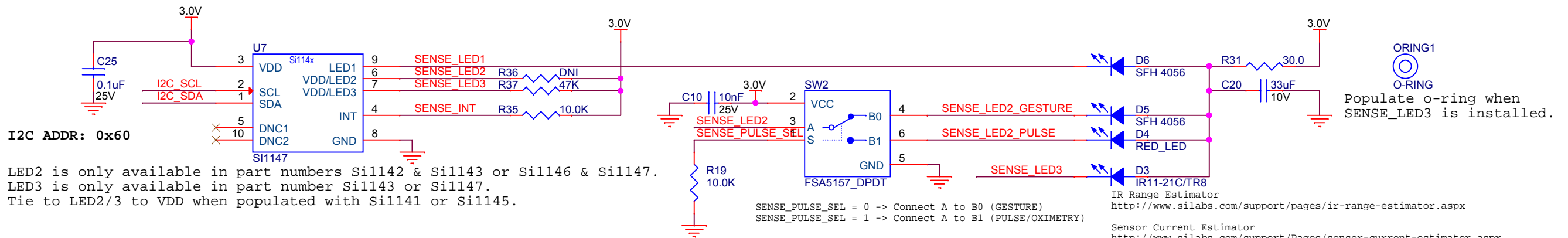


I2C ADDR: 0x40
I2C Clock @ 400kHz (Maximum)

LAYOUT NOTE:
DNC should be left floating or tied to VDD. (Solder to pads on PCB.)
PAD_NC should be electrically floating. (Solder to pads on PCB.)



Proximity/UV/Amb Light Sensor



I2C ADDR: 0x60

LED2 is only available in part numbers Si1142 & Si1143 or Si1146 & Si1147.
LED3 is only available in part number Si1143 or Si1147.
Tie to LED2/3 to VDD when populated with Si1141 or Si1145.

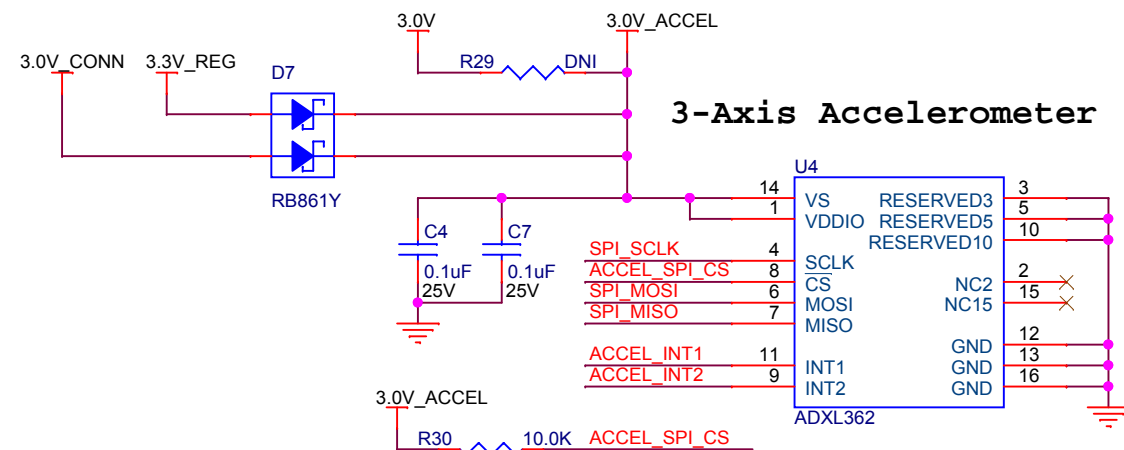
SENSE_PULSE_SEL = 0 -> Connect A to B0 (GESTURE)
SENSE_PULSE_SEL = 1 -> Connect A to B1 (PULSE/OXIMETRY)

IR Range Estimator
<http://www.silabs.com/support/pages/ir-range-estimator.aspx>
Sensor Current Estimator
<http://www.silabs.com/support/Pages/sensor-current-estimator.aspx>

Si1147 Default - SENSE_PULSE_SEL = 0
Gesture functionality - 2 IR LEDs (SFH 4056-NQ) spaced as far away as possible. (D5 and D6)
HRM functionality - 1 IR LED (IR11-21C/TR8) placed as close as possible. (D3)

Si1147 Optional Control - SENSE_PULSE_SEL = 1
Pulse/Ox - 1 0805 RED LED (new LED, doesn't exist on Rev A) and 1 IrLED placed as close as possible to each other and to the sensor. (D4 and D3)

3-Axis Accelerometer



LAYOUT NOTE:
1. Capacitor placement
- Place 0.1uF near pin 14
- Place 0.1uF near pin 1



SPI_USB_CSn R12 DNI SPI_CS

SPI_CS R11 0 ACCEL_SPI_CS

By default the BLE masters the ADI SPI. Populate 0-ohm resistor to allow the uController to master the ADI SPI.

Remove 0-ohm resistor to allow a device other than the accelerometer to be the slave on the SPI chain.



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